

	Type	Hits	Search Text	DBs
37	BRS	59	((438/622,623,624,634,637,725,763,780,781,789,790).CCLS.) and (sic or silicon adj carbide)) and hydrogenated	USPAT
38	BRS	24	((257/635,640,642,643,758,759).CCLS.) and (sic or silicon adj carbide)) and hydrogenated	USPAT
39	BRS	91	hydrogenated adj silicon adj (carbon or carbide)	USPAT
40	BRS	41	(hydrogenated adj silicon adj (carbon or carbide)) and @ad<"19980629"	USPAT
41	BRS	124	hydrogenated adj silicon adj (carbon or carbide)	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB
42	BRS	169	(SiCOH SiCH) and (semiconductor interconnect interconnection)	USPAT
43	BRS	894	(SiCOH SiCH) and (semiconductor interconnect interconnection)	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB
44	BRS	24	hydrogenated adj oxidized adj silicon adj carbon	USPAT
45	BRS	24	hydrogenated adj oxidized adj silicon adj carbon	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB
46	BRS	62	((438/622,623,624,634,637,725,763,780,781,789,790).CCLS.) and (sic or silicon adj carbide)) and hydrogenated	USPAT
47	BRS	24	((257/635,640,642,643,758,759).CCLS.) and (sic or silicon adj carbide)) and hydrogenated	USPAT
48	BRS	98	hydrogenated adj silicon adj (carbon or carbide)	USPAT
49	BRS	41	(hydrogenated adj silicon adj (carbon or carbide)) and @ad<"19980629"	USPAT
50	BRS	140	hydrogenated adj silicon adj (carbon or carbide)	US-PGPUB; USOCR; EPO; JPO; DERWENT; IBM_TDB
51	BRS	197	(SiCOH SiCH) and (semiconductor interconnect interconnection)	USPAT
52	BRS	64	(SiCOH SiCH) and (semiconductor interconnect interconnection) and (composition)	USPAT